

FORM PTO-1595
P24305.P03

10-06-2003



U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE

To the Honorable Director of Pat

102566981

Final documents or copy thereof.

1. Name of Conveying party(ies):

KOYAMA, Atsushi,
USAMI, Mamoru
YAMAGA, Kenji
DOMON, Mikio
SUZAWA, Kazuki

9.24.03

2. Name and address of receiving party(ies)

Name: TDK Corporation

Internal Address:

Street Address: 1-13-1, Nihonbashi, Chuo-ku,

Tokyo 103-8272, Japan

City: State: ZIP

Additional name(s) and address(es) attached? Yes ☒ No

Additional name(s) of conveying party(ies) attached? Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: August 21, 20, 21, 26 and 20, 2003

4. Application number(s) or patent number(s):

10668154

If this document is being filed together with a new application, the execution date of the application is: August 21, 20, 21, 26 and 20, 2003

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached: Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Bruce H. Bernstein

Internal Address: P 24305

09/26/2003 FFANAEIA 00000064 10668154

02 FC:9021

40.00 DP

Street Address: GREENBLUM & BERNSTEIN, P.L.C.

1950 Roland Clarke Place

City: Reston State: VA ZIP: 20191

6. Total number of applications and patents involved: 1

7. Total Fee (37 CFR 3.41).....\$ 40.00

☒ Enclosed

☐ Authorized to be charged to deposit account

8. Deposit account number:

19-0089

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Bruce H. Bernstein, Reg. No. 29,027

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and document: 4

Mail documents to be recorded with required cover sheet information to:
Director of the United States Patent and Trademark office, Mail Stop Assignments
PO Box 1450 Alexandria, Virginia 22313-1450

PATENT
REEL: 014547 FRAME: 0040

Assignment for more than one inventors

PAGE -1-

ASSIGNMENT

WHEREAS, **Atsushi KOYAMA**, a citizen of Japan, whose post office address is c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, **Mamoru USAMI**, a citizen of Japan, whose post office address is c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, , **Kenji YAMAGA**, a citizen of Japan, whose post office address is c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, **Mikio DOMON**, a citizen of Japan, whose post office address is c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan and **Kazuki SUZAWA**, a citizen of Japan, whose post office address is c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to

MOLD COMPONENT AND MOLD ASSEMBLY

for which they have jointly executed an application for Letters Patent of the United States to be filed in the United States Patent and Trademark Office.

If this Assignment is filed after the filing date of the above-identified application, the undersigned hereby authorize and request any one of the attorneys of record in this application including Neil F. Greenblum, Reg. No. 28,394, Bruce H. Bernstein, Reg. No. 29,027, Arnold Turk, Reg. No. 33,094, James L. Rowland, Reg. No. 32,674, Stephen M. Roylance, Reg. No. 31,296, Leslie J. Paperner, Reg. No. 33,329, William Pieprz, Reg. No. 33,630, and William E. Lyddane, Reg. No. 41,568, of the firm Greenblum & Bernstein, P.L.C., whose address is 1950 Roland Clarke Place, Reston, Virginia 20191, to insert here in parenthesis (Application No. _____, filed _____) the filing date and application number of said application when known.

AND WHEREAS, **TDK Corporation**, a corporation organized and existing under the laws of the State of Japan, whose post-office address is 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, hereinafter known as the ASSIGNEE, is desirous of acquiring the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, and prolongations thereof.

NOW, THIS WITNESSETH that for and in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEE, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefore, said ASSIGNEE and its assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and

continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNORS, on the respective date(s) indicated below.

Witnessed by:

Name Date



Atsushi KOYAMA 8/21/2003
Date

Name Date

Witnessed by:

Name Date



Mamoru USAMI 20. Aug. 2003
Date

Name Date

Witnessed by:

Name Date

Kenji Yamaga 8/21/2003
Kenji YAMAGA Date

Name Date

Witnessed by:

Name Date

Mikio Domon 8/26/2003
Mikio DOMON Date

Name Date

Witnessed by:

Name Date

Kazuki Suzawa 20. Aug. 2003
Kazuki SUZAWA Date

Name Date